



Micro Commercial Components 130 W Cochran St, Unit B Simi Valley, CA 93065 USA Tel:818-701-4933 MT200CB08T2 MT200CB12T2 MT200CB16T2 MT200CB18T2

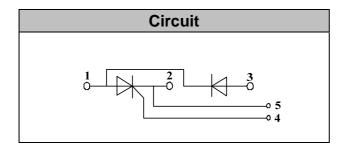
Features

- Lead Free Finish/RoHS Compliant (NOTE 1)("P" Suffix designates RoHS Compliant. See ordering information)
- International standard package
- Heat transfer through aluminum oxide DBC ceramic isolated metal baseplate
- · Glass passivated chip
- Simple Mounting

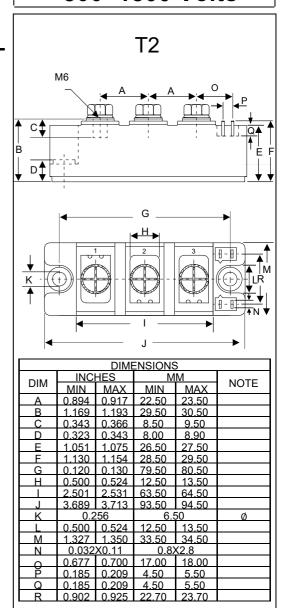
Applications

- Power Converters
- Lighting Control
- DC Motor Control and Drives
- · Heat and temperature control





200 Amp THYRISTOR/DIODE MODULE 800~1800 Volts





Module Type

| TYPE | VRRM/VDRM | Vrsm |
|-------------|-----------|-------|
| MT200CB08T2 | 800V | 900V |
| MT200CB12T2 | 1200V | 1300V |
| MT200CB16T2 | 1600V | 1700V |
| MT200CB18T2 | 1800V | 1900V |

♦Diode

Maximum Ratings

| Symbol | Item | Conditions | Values | Units |
|------------------|------------------------------------|----------------------|-------------|------------------------|
| ΙD | Output Current(D.C.) | Tc=85℃ | 200 | Α |
| IFSM | Surge forward current | t=10mS Tvj =45℃ | 6800 | Α |
| i ² t | Circuit Fusing Consideration | | 231200 | A^2s |
| Visol | Isolation Breakdown Voltage(R.M.S) | a.c.50HZ;r.m.s.;1min | 3000 | V |
| Tvj | Operating Junction Temperature | | -40 to +125 | $^{\circ}\!\mathbb{C}$ |
| Tstg | Storage Temperature | | -40 to +125 | $^{\circ}$ |
| Mt | Mounting Torque | To terminals(M6) | 3±15% | Nm |
| Ms | | To heatsink(M6) | 5±15% | Nm |
| Weight | Module (Approximately) | | 165 | g |

Thermal Characteristics

| Symbol | Item | Conditions | Values | Units |
|----------|-------------------------|------------------|--------|-------|
| Rth(j-c) | Thermal Impedance, max. | Junction to Case | 0.08 | °C/W |
| Rth(c-s) | Thermal Impedance, max. | Case to Heatsink | 0.05 | °C/W |

Electrical Characteristics

| Symbol | ltem | Conditions | Values | | | Units |
|----------|---------------------------------------|---|------------|------|------|----------|
| Syllibol | Rem | Conditions | Min. | Тур. | Max. | Units |
| VFM | Forward Voltage Drop, max. | T=25°C IF =620A | | | 1.70 | V |
| IRRM | Repetitive Peak Reverse Current, max. | Tvj =25°C VRD=VRRM Tvj =125°C VRD=VRRM | ≤0.5 ≤9 | | | mA mA |



♦Thyristor

Maximum Ratings

| Symbol | Item | Conditions | Values | Units |
|------------------|--|---|------------------|------------------|
| I _{TAV} | Average On-State Current | Sine 180°;Tc=85℃ | 200 | Α |
| I _{TSM} | Surge On-State Current | T_{VJ} =45°C t=10ms, sine T_{VJ} =125°C t=10ms, sine | 5500 5000 | Α |
| i ² t | Circuit Fusing Consideration | T_{VJ} =45°C t=10ms, sine T_{VJ} =125°C t=10ms, sine | 151000 125000 | A2s |
| Visol | Isolation Breakdown Voltage(R.M.S) | a.c.50HZ;r.m.s.;1min | 3000 | V |
| Tvj | Operating Junction Temperature | | -40 to +130 | $^{\circ}$ |
| Tstg | Storage Temperature | | -40 to +125 | $^{\circ}$ |
| Mt | Mounting Torque | To terminals(M6) | $3\pm15\%$ | Nm |
| Ms | | To heatsink(M6) | $5\!\pm\!15\%$ | Nm |
| di/dt | Critical Rate of Rise of On-State Current | T_{VJ} = T_{VJM} , 2/3 V_{DRM} , I_{G} =500mA Tr<0.5us,tp>6us | 200 | A/us |
| dv/dt | Critical Rate of Rise of Off-State Voltage, min. | T _J =T _{VJM} ,2/3V _{DRM} linear voltage rise | 1000 | V/us |
| а | Maximum allowable acceleration | | 50 | m/s ² |

Thermal Characteristics

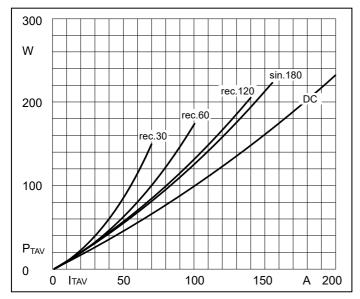
| Symbol | Item | Conditions | Values | Units |
|----------|-------------------------|------------------|--------|-------|
| Rth(j-c) | Thermal Impedance, max. | Junction to Case | 0.16 | °C/W |
| Rth(c-s) | Thermal Impedance, max. | Case to Heatsink | 0.10 | °C/W |

Electrical Characteristics

| 0 | | 6 1141 | Values | | | |
|------------------------------------|--|---|--------|-----|------|-------|
| Symbol | Item | Conditions | | | | Units |
| V_{TM} | Peak On-State Voltage, max. | T=25°C I _T =620A | | | 1.70 | V |
| I _{RRM} /I _{DRM} | Repetitive Peak Reverse Current, max. / Repetitive Peak Off-State Current, max. | $T_{VJ}=T_{VJM}$, $V_R=V_{RRM}$, $V_D=V_{DRM}$ | | | 40 | mA |
| V _{TO} | On state threshold voltage For power-loss calculations only (T _{VJ} =125℃) | | | | 0.85 | V |
| r _T | Value of on-state slope resistance. max | $T_{VJ} = T_{VJM}$ | | | 1.5 | mΩ |
| V_{GT} | Gate Trigger Voltage, max. | T_{VJ} =25°C , V_D =6V | | 3 | | V |
| I _{GT} | Gate Trigger Current, max. | $T_{VJ} = 25^{\circ}C$, $V_D = 6V$ | | 200 | | mA |
| V_{GD} | Non-triggering gate voltage, max. | T_{VJ} =125°C, V_D =2/3 V_{DRM} | | | 0.25 | V |
| I_{GD} | Non-triggering gate current, max. | T_{VJ} =125°C, V_D =2/3 V_{DRM} | | 10 | | mA |
| IL | Latching current, max. | T_{VJ} =25°C , R_G = 33 Ω | | 300 | 1000 | mA |
| I _H | Holding current, max. | T_{VJ} =25°C , V_D =6V | | 150 | 400 | mA |
| tgd | Gate controlled delay time | T _{VJ} =25℃, I _G =1A, diG/dt=1A/us | 1 | | us | |
| tq | Circuit commutated turn-off time | $T_{VJ} = T_{VJM}$ | 100 | | us | |



Performance Curves



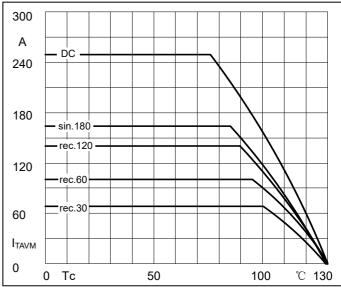
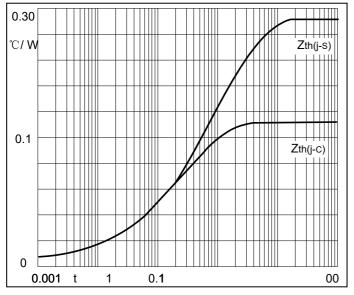


Fig1. Power dissipation

Fig2.Forward Current Derating Curve





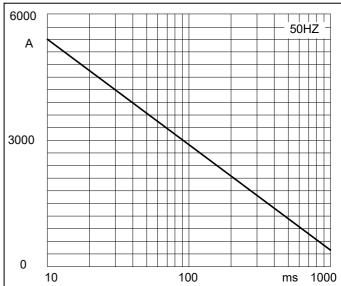


Fig4. Max Non-Repetitive Forward Surge Current



Performance Curves

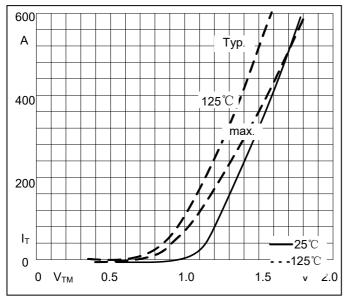


Fig5. Forward Characteristics

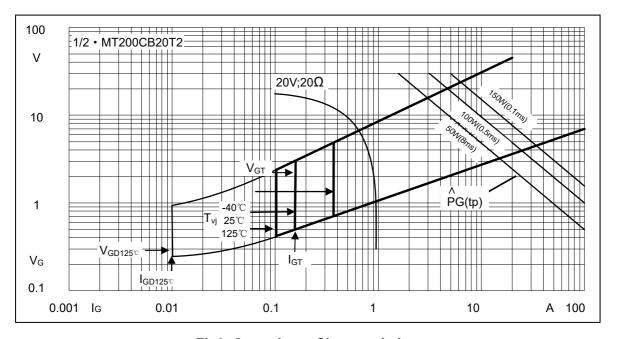


Fig6. Gate trigger Characteristics



Ordering Information:

| Device | Packing | | |
|----------------|--------------------------|--|--|
| Part Number-BP | Bulk: 8PCS/BOX;80PCS/CTN | | |

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|------------------|---------------------------|------------------|---------------|---------------|---------------------------|---------------|---------------------------|--------------------------------|
| 25.163.2453. | 0 25.163.4253.0 | 25.190.2053.0 | 25.194.3453.0 | 25.320.4853.1 | 25.320.5253.1 | 25.326.3253.1 | 25.326.3553.1 | 25.330.1653.1 |
| 25.330.4753. | 1 25.330.5253.1 | 25.334.3253.1 | 25.334.3353.1 | 25.350.2053.0 | 25.352.4753.1 | 25.522.3253.0 | <u>T483C</u> <u>T484C</u> | <u>T485F</u> <u>T485H</u> |
| <u>T512F-YEB</u> | <u>T513F</u> <u>T514F</u> | T554 T612FSE | 25.161.3453.0 | 25.179.2253.0 | 25.194.3253.0 | 25.325.1253.1 | 25.326.4253.1 | 25.330.0953.1 |
| 25.332.4353. | 1 25.350.1653.0 | 25.350.2453.0 | 25.352.1453.0 | 25.352.1653.0 | 25.352.2453.0 | 25.352.5453.1 | 25.522.3353.0 | 25.602.4053.0 |
| 25.640.5053. | 0 | | | | | | | |